

# 2SD1445A

## Silicon NPN epitaxial planar type

For power amplification, power switching and low-voltage switching  
Complementary to 2SB0948A

### ■ Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- High-speed switching
- Satisfactory linearity of forward current transfer ratio  $h_{FE}$
- Large collector current  $I_C$
- Full-pack package which can be installed to the heat sink with one screw.

### ■ Absolute Maximum Ratings $T_C = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	50	V
Collector-emitter voltage (Base open)	$V_{CEO}$	40	V
Emitter-base voltage (Collector open)	$V_{EBO}$	5	V
Collector current	$I_C$	10	A
Peak collector current	$I_{CP}$	20	A
Collector power dissipation	$P_C$	40	W
		2.0	
		$T_a = 25^\circ\text{C}$	
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

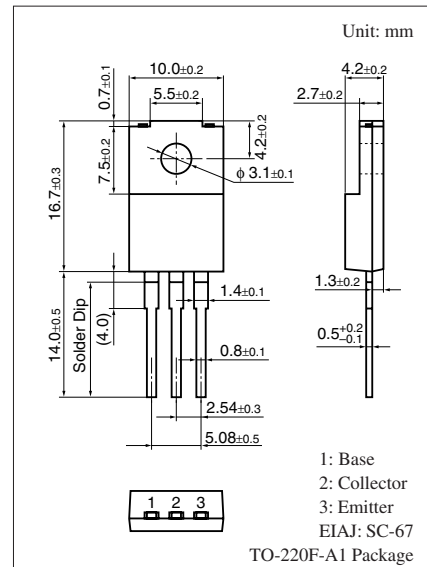
### ■ Electrical Characteristics $T_C = 25^\circ\text{C} \pm 3^\circ\text{C}$

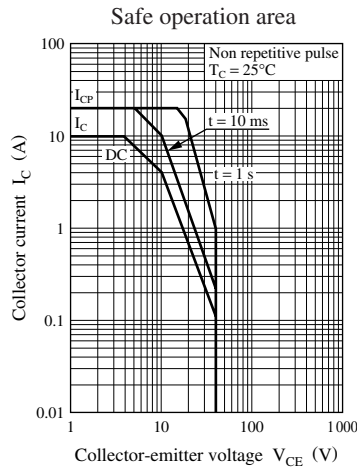
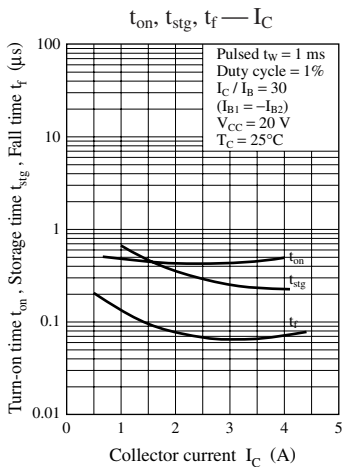
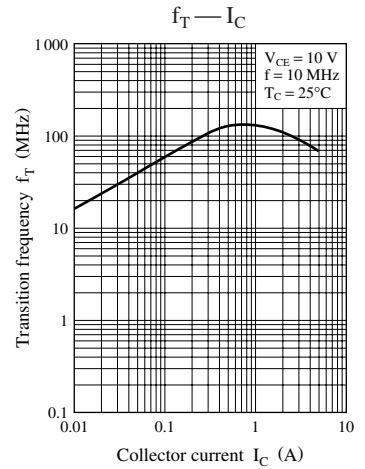
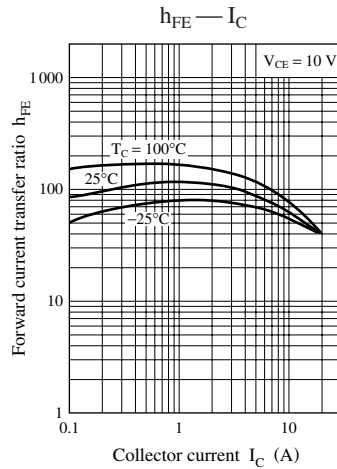
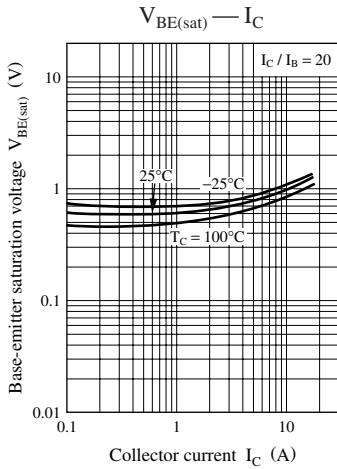
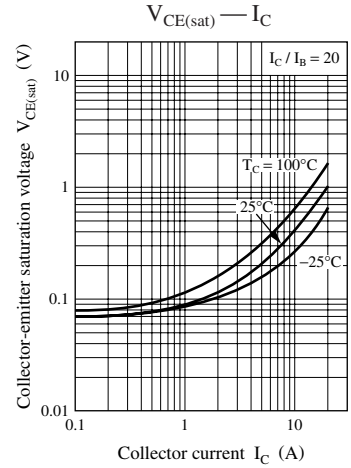
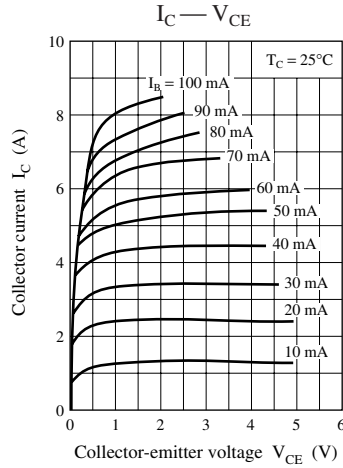
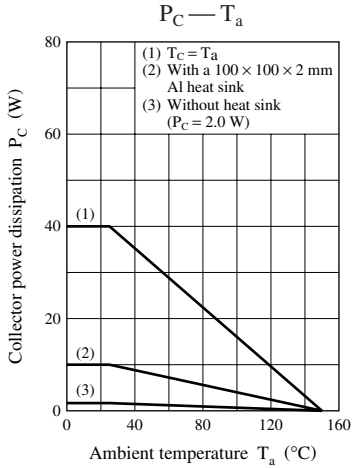
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter voltage (Base open)	$V_{CEO}$	$I_C = 10\text{ mA}$ , $I_B = 0$	40			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 50\text{ V}$ , $I_E = 0$			50	$\mu\text{A}$
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 5\text{ V}$ , $I_C = 0$			50	$\mu\text{A}$
Forward current transfer ratio	$h_{FE1}$	$V_{CE} = 2\text{ V}$ , $I_C = 0.1\text{ A}$	45			—
	$h_{FE2}^*$	$V_{CE} = 2\text{ V}$ , $I_C = 3\text{ A}$	60		260	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 10\text{ A}$ , $I_B = 0.33\text{ A}$			0.6	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 10\text{ A}$ , $I_B = 0.33\text{ A}$			1.5	V
Transition frequency	$f_T$	$V_{CE} = 10\text{ V}$ , $I_C = 0.5\text{ A}$ , $f = 10\text{ MHz}$		120		MHz
Collector output capacitance (Common base, input open circuited)	$C_{ob}$	$V_{CB} = 10\text{ V}$ , $I_E = 0$ , $f = 1\text{ MHz}$		200		pF
Turn-on time	$t_{on}$	$I_C = 3\text{ A}$ , $I_{B1} = 0.1\text{ A}$ , $I_{B2} = -0.1\text{ A}$ ,		0.3		$\mu\text{s}$
Storage time	$t_{stg}$	$V_{CC} = 20\text{ V}$		0.4		$\mu\text{s}$
Fall time	$t_f$			0.1		$\mu\text{s}$

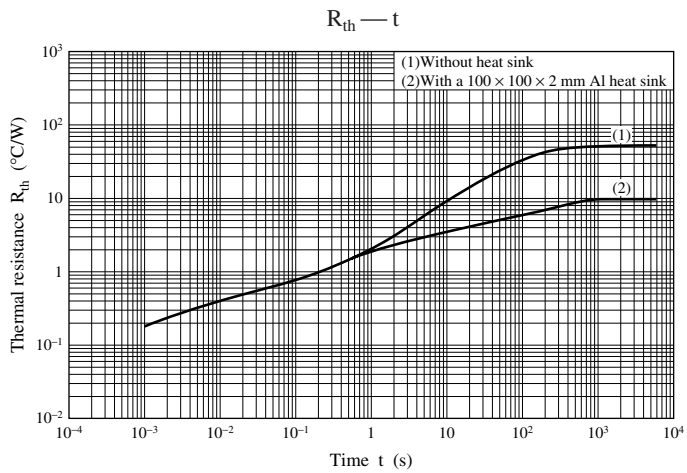
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	R	Q	P
$h_{FE2}$	60 to 120	90 to 180	130 to 260







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